



**CYPRESS**

**CY7C106  
CY7C1006**

## 256K x 4 Static RAM

### Features

- High speed
  - $t_{AA} = 12$  ns
- CMOS for optimum speed/power
- Low active power
  - 910 mW
- Low standby power
  - 275 mW
- 2.0V data retention (optional)
  - 100  $\mu$ W
- Automatic power-down when deselected
- TTL-compatible inputs and outputs

### Functional Description

The CY7C106 and CY7C1006 are high-performance CMOS static RAMs organized as 262,144 words by 4 bits. Easy memory expansion is provided by an active LOW chip enable (CE),

an active LOW output enable ( $\overline{OE}$ ), and three-state drivers. These devices have an automatic power-down feature that reduces power consumption by more than 65% when the devices are deselected.

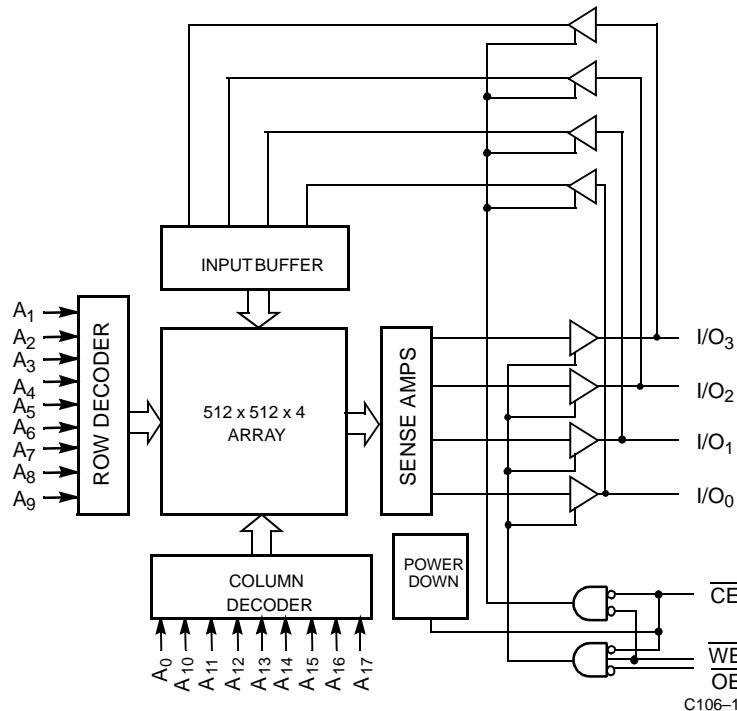
Writing to the devices is accomplished by taking chip enable (CE) and write enable (WE) inputs LOW. Data on the four I/O pins ( $I/O_0$  through  $I/O_3$ ) is then written into the location specified on the address pins ( $A_0$  through  $A_{17}$ ).

Reading from the devices is accomplished by taking chip enable (CE) and output enable ( $\overline{OE}$ ) LOW while forcing write enable (WE) HIGH. Under these conditions, the contents of the memory location specified by the address pins will appear on the four I/O pins.

The four input/output pins ( $I/O_0$  through  $I/O_3$ ) are placed in a high-impedance state when the devices are deselected (CE HIGH), the outputs are disabled ( $\overline{OE}$  HIGH), or during a write operation (CE and WE LOW).

The CY7C106 is available in a standard 400-mil-wide SOJ; the CY7C1006 is available in a standard 300-mil-wide SOJ.

### Logic Block Diagram



### Pin Configuration

SOJ Top View	
$A_0$	1 V <sub>CC</sub>
$A_1$	2 $A_{17}$
$A_2$	3 27
$A_3$	4 26
$A_4$	5 25
$A_5$	6 24
$A_6$	7 23
$A_7$	8 22
$A_8$	9 21
$A_9$	10 20
$A_{10}$	11 19
$A_{11}$	12 18
$A_{12}$	13 17
$A_{13}$	14 16
$A_{14}$	15 15
$A_{15}$	NC
$A_{16}$	$I/O_3$
$A_{17}$	$I/O_2$
CE	$I/O_1$
OE	$I/O_0$
GND	WE

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### Selection Guide

	7C106-12 7C1006-12	7C106-15 7C1006-15	7C106-20 7C1006-20	7C106-25 7C1006-25	7C106-35
Maximum Access Time (ns)	12	15	20	25	35
Maximum Operating Current (mA)	165	155	145	130	125
Maximum Standby Current (mA)	50	30	30	30	25

### Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature ..... $-65^{\circ}\text{C}$  to  $+150^{\circ}\text{C}$

Ambient Temperature with

Power Applied..... $-55^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$

Supply Voltage on  $V_{\text{CC}}$  Relative to GND<sup>[1]</sup> .... $-0.5\text{V}$  to  $+7.0\text{V}$

DC Voltage Applied to Outputs  
in High Z State<sup>[1]</sup> ..... $-0.5\text{V}$  to  $V_{\text{CC}} + 0.5\text{V}$

DC Input Voltage<sup>[1]</sup> ..... $-0.5\text{V}$  to  $V_{\text{CC}} + 0.5\text{V}$

Current into Outputs (LOW) ..... 20 mA

Static Discharge Voltage ..... >2001V  
(per MIL-STD-883, Method 3015)

Latch-Up Current.....>200 mA

### Operating Range

Range	Ambient Temperature <sup>[2]</sup>	$V_{\text{CC}}$
Commercial	$0^{\circ}\text{C}$ to $+70^{\circ}\text{C}$	$5\text{V} \pm 10\%$

### Electrical Characteristics Over the Operating Range

Parameter	Description	Test Conditions	7C106-12 7C1006-12		7C106-15 7C1006-15		7C106-20 7C1006-20		Unit
			Min.	Max.	Min.	Max.	Min.	Max.	
$V_{\text{OH}}$	Output HIGH Voltage	$V_{\text{CC}} = \text{Min.}$ , $I_{\text{OH}} = -4.0\text{ mA}$	2.4		2.4		2.4		V
$V_{\text{OL}}$	Output LOW Voltage	$V_{\text{CC}} = \text{Min.}$ , $I_{\text{OL}} = 8.0\text{ mA}$		0.4		0.4		0.4	V
$V_{\text{IH}}$	Input HIGH Voltage		2.2	$V_{\text{CC}} + 0.3$	2.2	$V_{\text{CC}} + 0.3$	2.2	$V_{\text{CC}} + 0.3$	V
$V_{\text{IL}}$	Input LOW Voltage <sup>[1]</sup>		-0.3	0.8	-0.3	0.8	-0.3	0.8	V
$I_{\text{IX}}$	Input Load Current	$\text{GND} \leq V_{\text{I}} \leq V_{\text{CC}}$	-1	+1	-1	+1	-1	+1	$\mu\text{A}$
$I_{\text{OZ}}$	Output Leakage Current	$\text{GND} \leq V_{\text{I}} \leq V_{\text{CC}}$ , Output Disabled	-5	+5	-5	+5	-5	+5	$\mu\text{A}$
$I_{\text{OS}}$	Output Short Circuit Current <sup>[3]</sup>	$V_{\text{CC}} = \text{Max.}$ , $V_{\text{OUT}} = \text{GND}$		-300		-300		-300	mA
$I_{\text{CC}}$	$V_{\text{CC}}$ Operating Supply Current	$V_{\text{CC}} = \text{Max.}$ , $I_{\text{OUT}} = 0\text{ mA}$ , $f = f_{\text{MAX}} = 1/t_{\text{RC}}$		165		155		140	mA
$I_{\text{SB1}}$	Automatic CE Power-Down Current —TTL Inputs	Max. $V_{\text{CC}}$ , $\overline{\text{CE}} \geq V_{\text{IH}}$ , $V_{\text{IN}} \geq V_{\text{IH}}$ or $V_{\text{IN}} \leq V_{\text{IL}}$ , $f = f_{\text{MAX}}$		50		30		30	mA
$I_{\text{SB2}}$	Automatic CE Power-Down Current —CMOS Inputs	Max. $V_{\text{CC}}$ , $\overline{\text{CE}} \geq V_{\text{CC}} - 0.3\text{V}$ , $V_{\text{IN}} \geq V_{\text{CC}} - 0.3\text{V}$ or $V_{\text{IN}} \leq 0.3\text{V}$ , $f=0$	Com'l L	10 2		10 2		10 2	mA

**Notes:**

1.  $V_{\text{IL}}$  (min.) =  $-2.0\text{V}$  for pulse durations of less than 20 ns.

2.  $T_A$  is the "instant on" case temperature.

3. Not more than 1 output should be shorted at one time. Duration of the short circuit should not exceed 30 seconds.

**Electrical Characteristics** Over the Operating Range (continued)

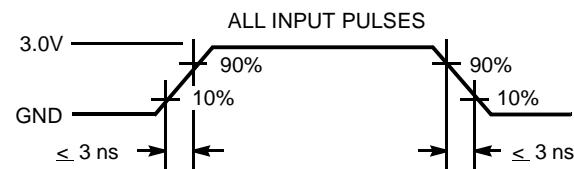
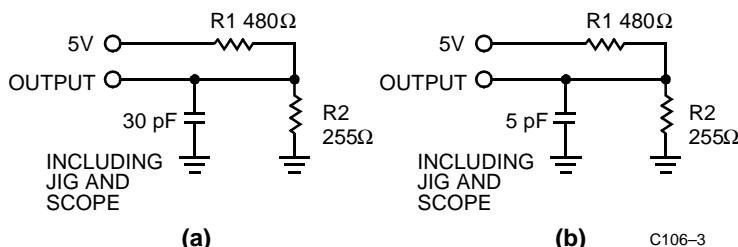
Parameter	Description	Test Conditions	7C106-25 7C1006-25		7C106-35		Unit
			Min.	Max.	Min.	Max.	
$V_{OH}$	Output HIGH Voltage	$V_{CC} = \text{Min.}$ , $I_{OH} = -4.0 \text{ mA}$	2.4		2.4		V
$V_{OL}$	Output LOW Voltage	$V_{CC} = \text{Min.}$ , $I_{OL} = 8.0 \text{ mA}$		0.4		0.4	V
$V_{IH}$	Input HIGH Voltage		2.2	$V_{CC} + 0.3$	2.2	$V_{CC} + 0.3$	V
$V_{IL}$	Input LOW Voltage <sup>[1]</sup>		-0.3	0.8	-0.3	0.8	V
$I_{IX}$	Input Load Current	$GND \leq V_I \leq V_{CC}$	-1	+1	-1	+1	$\mu\text{A}$
$I_{OZ}$	Output Leakage Current	$GND \leq V_I \leq V_{CC}$ , Output Disabled	-5	+5	-5	+5	$\mu\text{A}$
$I_{OS}$	Output Short Circuit Current <sup>[3]</sup>	$V_{CC} = \text{Max.}$ , $V_{OUT} = GND$		-300		-300	mA
$I_{CC}$	$V_{CC}$ Operating Supply Current	$V_{CC} = \text{Max.}$ , $I_{OUT} = 0 \text{ mA}$ , $f = f_{MAX} = 1/t_{RC}$		130		125	mA
$I_{SB1}$	Automatic CE Power-Down Current — TTL Inputs	Max. $V_{CC}$ , $CE \geq V_{IH}$ , $V_{IN} \geq V_{IH}$ or $V_{IN} \leq V_{IL}$ , $f = f_{MAX}$		30		25	mA
$I_{SB2}$	Automatic CE Power-Down Current — CMOS Inputs	Max. $V_{CC}$ , $CE \geq V_{CC} - 0.3V$ , $V_{IN} \geq V_{CC} - 0.3V$ or $V_{IN} \leq 0.3V$ , $f=0$	Com'l		10		10
			L		2		2

**Capacitance<sup>[4]</sup>**

Parameter	Description	Test Conditions	Max.	Unit
$C_{IN}$ : Addresses	Input Capacitance	$T_A = 25^\circ\text{C}$ , $f = 1 \text{ MHz}$ , $V_{CC} = 5.0\text{V}$	7	pF
$C_{IN}$ : Controls			10	pF
$C_{OUT}$	Output Capacitance		10	pF

Note:

4. Tested initially and after any design or process changes that may affect these parameters.

**AC Test Loads and Waveforms**


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Equivalent to: THÉVENIN EQUIVALENT



**Switching Characteristics** Over the Operating Range<sup>[5]</sup>

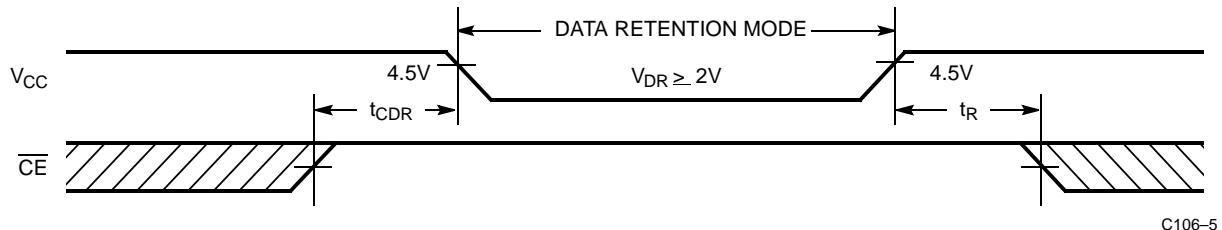
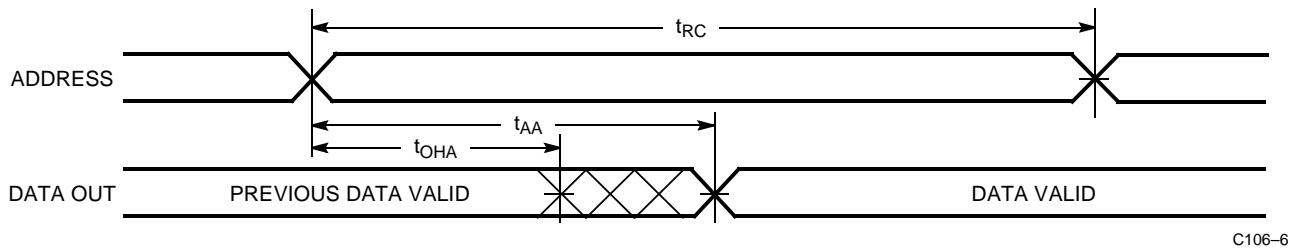
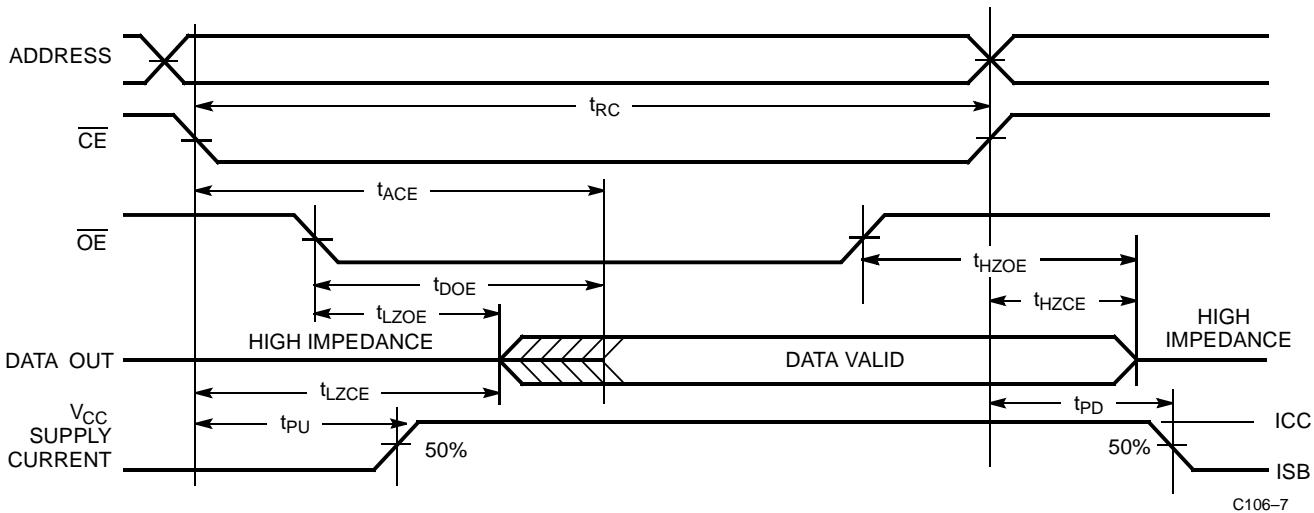
Parameter	Description	7C106-12 7C1006-12		7C106-15 7C1006-15		7C106-20 7C1006-20		7C106-25 7C1006-25		7C106-35		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
<b>READ CYCLE</b>												
t <sub>RC</sub>	Read Cycle Time	12		15		20		25		35		ns
t <sub>AA</sub>	Address to Data Valid		12		15		20		25		35	ns
t <sub>OHA</sub>	Data Hold from Address Change	3		3		3		3		3		ns
t <sub>ACE</sub>	CE LOW to Data Valid		12		15		20		25		35	ns
t <sub>DOE</sub>	OE LOW to Data Valid		6		7		8		10		10	ns
t <sub>LZOE</sub>	OE LOW to Low Z	0		0		0		0		0		ns
t <sub>HZOE</sub>	OE HIGH to High Z <sup>[6,7]</sup>		6		7		8		10		10	ns
t <sub>LZCE</sub>	CE LOW to Low Z <sup>[7]</sup>	3		3		3		3		3		ns
t <sub>HZCE</sub>	CE HIGH to High Z <sup>[6,7]</sup>		6		7		8		10		10	ns
t <sub>PU</sub>	CE LOW to Power-Up	0		0		0		0		0		ns
t <sub>PD</sub>	CE HIGH to Power-Down		12		15		20		25		35	ns
<b>WRITE CYCLE</b> <sup>[8,9]</sup>												
t <sub>WC</sub>	Write Cycle Time	12		15		20		25		35		ns
t <sub>SCE</sub>	CE LOW to Write End	10		12		15		20		25		ns
t <sub>AW</sub>	Address Set-Up to Write End	10		12		15		20		25		ns
t <sub>HA</sub>	Address Hold from Write End	0		0		0		0		0		ns
t <sub>SA</sub>	Address Set-Up to Write Start	0		0		0		0		0		ns
t <sub>PWE</sub>	WE Pulse Width	10		12		15		20		25		ns
t <sub>SD</sub>	Data Set-Up to Write End	7		8		10		15		20		ns
t <sub>HD</sub>	Data Hold from Write End	0		0		0		0		0		ns
t <sub>LZWE</sub>	WE HIGH to Low Z <sup>[7]</sup>	2		3		3		3		3		ns
t <sub>HZWE</sub>	WE LOW to High Z <sup>[6,7]</sup>		6		7		8		10		10	ns

**Notes:**

5. Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V, and output loading of the specified I<sub>OL</sub>/I<sub>OH</sub> and 30-pF load capacitance.
6. t<sub>HZOE</sub>, t<sub>HZCE</sub>, and t<sub>HZWE</sub> are specified with a load capacitance of 5 pF as in part (b) of AC Test Loads. Transition is measured  $\pm 500$  mV from steady-state voltage.
7. At any given temperature and voltage condition, t<sub>HZCE</sub> is less than t<sub>ZCE</sub>; t<sub>HZOE</sub> is less than t<sub>ZOE</sub>; and t<sub>HZWE</sub> is less than t<sub>ZWE</sub> for any given device.
8. The internal write time of the memory is defined by the overlap of CE and WE LOW. CE and WE must be LOW to initiate a write, and the transition of either of these signals can terminate the write. The input data set-up and hold timing should be referenced to the leading edge of the signal that terminates the write.
9. The minimum write cycle time for Write Cycle No. 3 (WE controlled, OE LOW) is the sum of t<sub>HZWE</sub> and t<sub>SD</sub>.

**Data Retention Characteristics** Over the Operating Range (L Version Only)

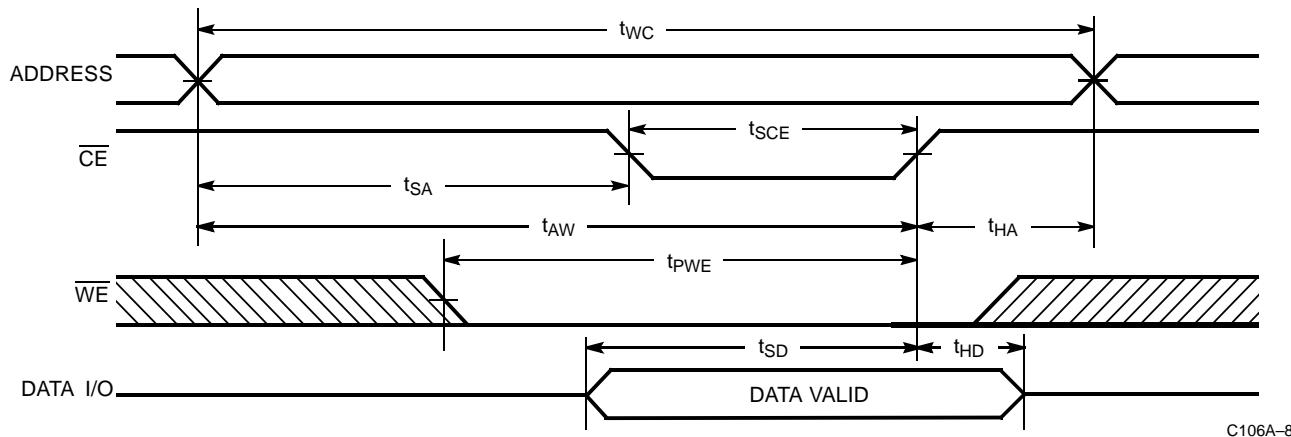
Parameter	Description	Conditions <sup>[10]</sup>	Min.	Max.	Unit
$V_{DR}$	$V_{CC}$ for Data Retention		2.0		V
$I_{CCDR}$	Data Retention Current	$V_{CC} = V_{DR} = 2.0V$ , $CE \geq V_{CC} - 0.3V$ , $V_{IN} \geq V_{CC} - 0.3V$ or $V_{IN} \leq 0.3V$		50	$\mu A$
$t_{CDR}^{[4]}$	Chip Deselect to Data Retention Time		0		ns
$t_R^{[4]}$	Operation Recovery Time	$V_{IN} \leq 0.3V$	$t_{RC}$		ns

**Data Retention Waveform**

**Switching Waveforms**
**Read Cycle No. 1<sup>[11, 12]</sup>**

**Read Cycle No. 2 (OE Controlled)<sup>[12, 13]</sup>**

**Notes:**

10. No input may exceed  $V_{CC} + 0.5V$ .
11. Device is continuously selected,  $\overline{OE}$  and  $\overline{CE} = V_{IL}$ .
12. WE is HIGH for read cycle.
13. Address valid prior to or coincident with  $\overline{CE}$  transition LOW.

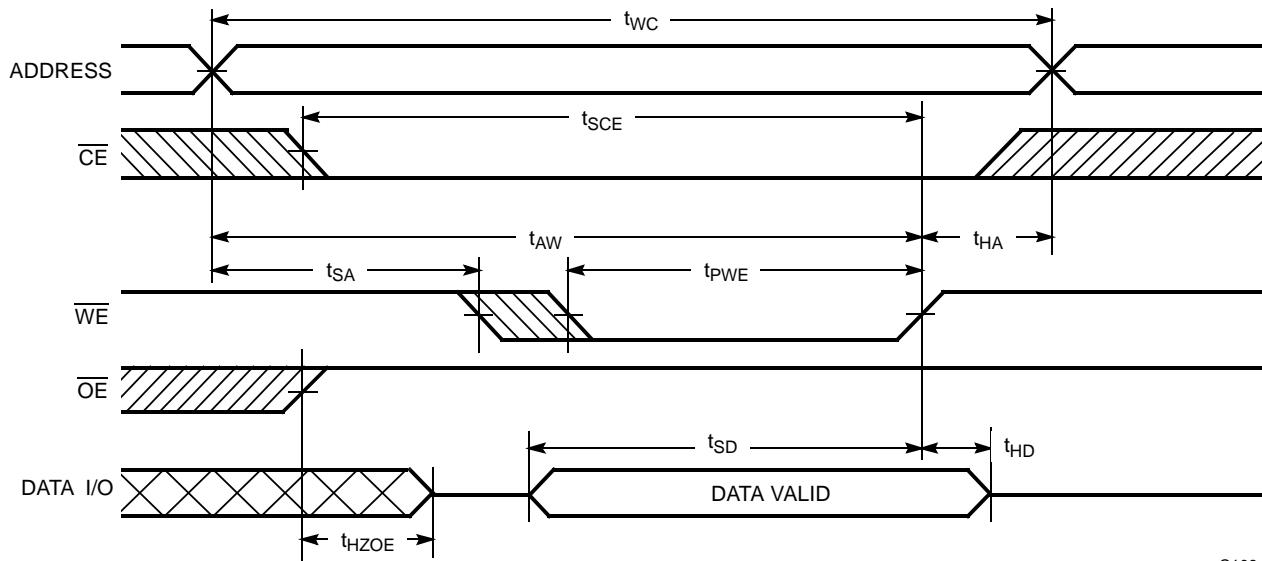
### Switching Waveforms (continued)

**Write Cycle No. 1 ( $\overline{CE}$  Controlled)<sup>[14, 15]</sup>**



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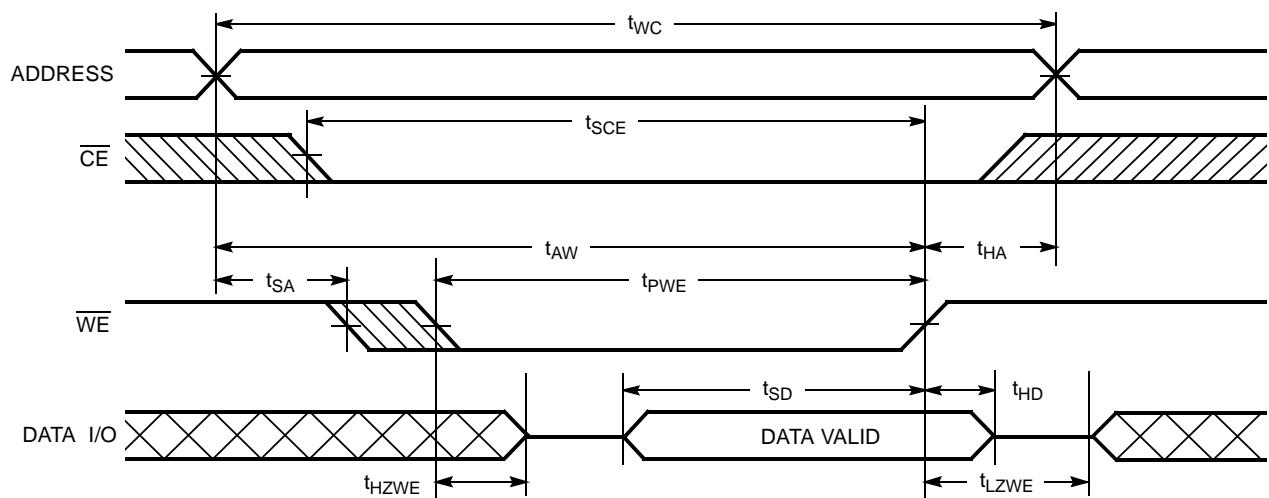
### Write Cycle No. 2 ( $\overline{WE}$ Controlled, $\overline{OE}$ HIGH During Write)<sup>[14, 15]</sup>



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**Notes:**

14. If  $\overline{CE}$  goes HIGH simultaneously with  $\overline{WE}$  going HIGH, the output remains in a high-impedance state.
15. Data I/O is high impedance if  $OE = V_{IH}$ .

**Switching Waveforms (continued)**
**Write Cycle No. 3 ( $\overline{WE}$  Controlled,  $OE$  LOW)<sup>[9, 15]</sup>**


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**Truth Table**

CE	$\overline{OE}$	$\overline{WE}$	Input/Output	Mode	Power
H	X	X	High Z	Power-Down	Standby ( $I_{SB}$ )
L	L	H	Data Out	Read	Active ( $I_{CC}$ )
L	X	L	Data In	Write	Active ( $I_{CC}$ )
L	H	H	High Z	Selected, Outputs Disabled	Active ( $I_{CC}$ )

**Ordering Information**

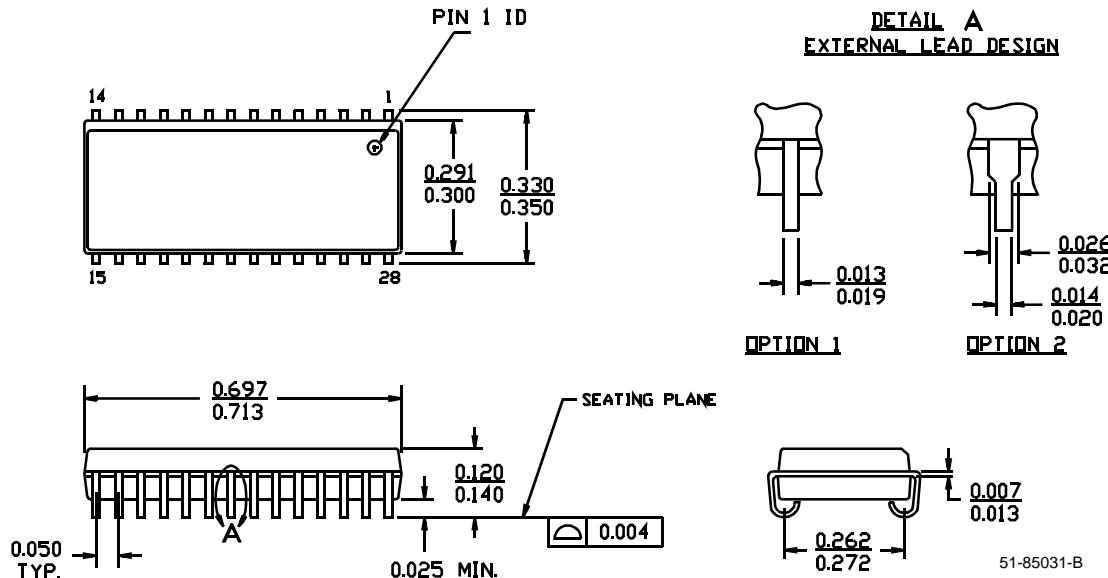
Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
12	CY7C106-12VC	V28	28-Lead (400-Mil) Molded SOJ	Commercial
	CY7C1006-12VC	V21	28-Lead (300-Mil) Molded SOJ	
15	CY7C106-15VC	V28	28-Lead (400-Mil) Molded SOJ	Commercial
	CY7C1006-15VC	V21	28-Lead (300-Mil) Molded SOJ	
20	CY7C106-20VC	V28	28-Lead (400-Mil) Molded SOJ	Commercial
	CY7C1006-20VC	V21	28-Lead (300-Mil) Molded SOJ	
25	CY7C106-25VC	V28	28-Lead (400-Mil) Molded SOJ	Commercial
	CY7C1006-25VC	V21	28-Lead (300-Mil) Molded SOJ	
35	CY7C106-35VC	V28	28-Lead (400-Mil) Molded SOJ	Commercial

Contact factory for "L" version availability.

## Package Diagrams

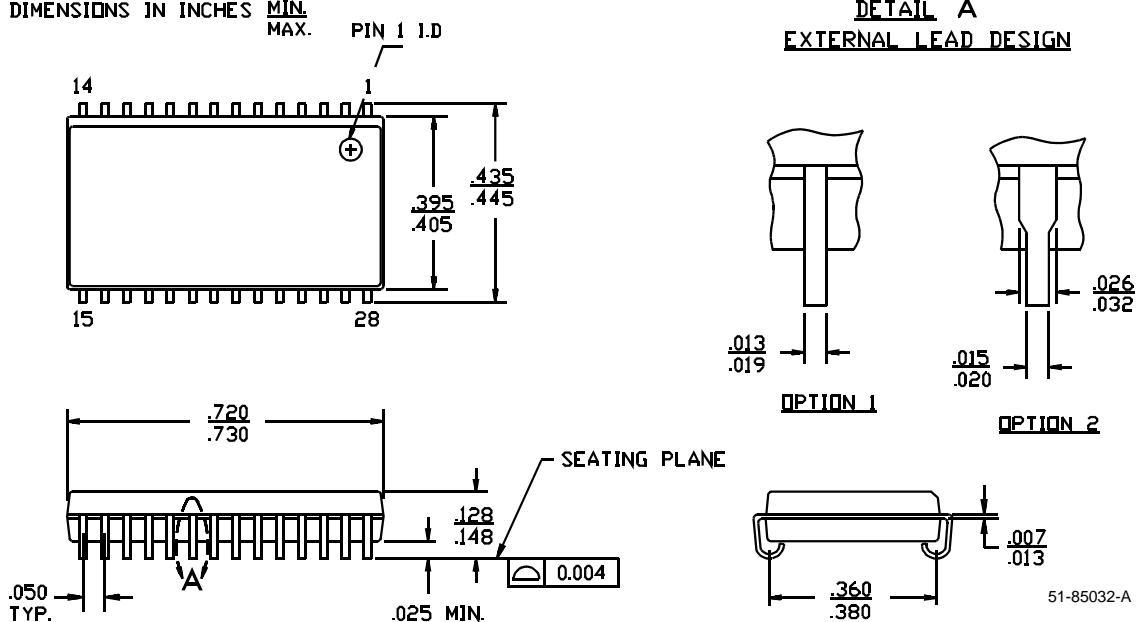
### 28-Lead (300-Mil) Molded SOJ V21

DIMENSIONS IN INCHES    MIN.    MAX.



### 28-Lead (400-Mil) Molded SOJ V28

DIMENSIONS IN INCHES    MIN.    MAX.





**CY7C106  
CY7C1006**

**Document Title: CY7C106, CY7C1006 256K x 4 Static RAM  
Document Number: 38-05033**

<b>REV.</b>	<b>ECN NO.</b>	<b>Issue Date</b>	<b>Orig. of Change</b>	<b>Description of Change</b>
**	106827	06/12/01	SZV	Change from Spec #: 38-00230 to 38-05033